D2932, MARCH 1987-REVISED JANUARY 1989

- Inverting Versions of SN54F153 and SN74F153
- Permits Multiplexing from N Lines to 1 Line
- Performs Parallel-to-Serial Conversion
- Strobe (Enable) Line Provided for Cascading (N Lines to n Lines)
- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs
- Dependable Texas Instruments Quality and Reliability

description

Each of these data selectors/multiplexers contains inverters and drivers to supply fully complementary binary decoding data selection to the AND-OR-invert gates. Separate strobe inputs (\overline{G}) are provided for each of the two four-line sections.

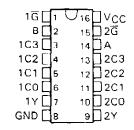
The SN54F352 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74F352 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

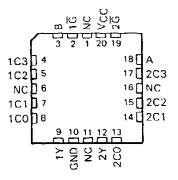
| SELECT INPUTS | | | DATA | INPUT | STROBE | OUTPUT | |
|------------------|-----|----|------|-------|--------|--------|---|
| В | А | CO | C1 | Ç2 | Ç3 | | |
| X | Х | X | Х | X | Х | Н | Н |
| L | L | L | Х | Х | Х | L | Н |
| L | L | н | Х | Х | X | L | L |
| L | Н | Х | L | Х | X | L | н |
| L | Н | Х | Н | Х | X | L | L |
| H | L ! | х | Х | L | Х | Ļ | Н |
|] н | L | Х | Х | Н | Х | L | L |
| Н | н | Х | X | Х | L | Ļ | н |
| Н | Н | х | Χ | X | Н | Ĺ | L |

Select inputs A and B are common to both sections.

SN54F352 . . . J PACKAGE SN74F352 . . . D OR N PACKAGE (TOP VIEW)

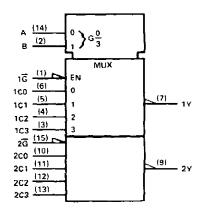


\$N54F352 . . . FK PACKAGE (TOP VIEW)



NC-No internal connection

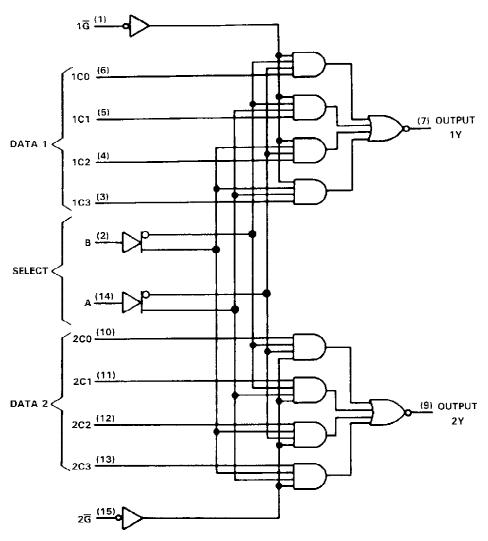
logic symbol†



[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, and N packages.

logic diagram (positive logic)



Pin numbers shown are for D, J, and N packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC | -0.5 V to 7 V |
|---|---------------|
| Input current | 0 mA to 5 mA |
| Voltage applied to any output in the high state | -0.5 V to VCC |
| Current into any output in the low state | 40 mA |
| Operating free-air temperature range: SN54F352 | 5°C to 125°C |
| SN74F352 | 0°C to 70°C |
| Storage temperature range6 | |

[†]The input voltage ratings may be exceeded provided the input current ratings are observed.



recommended operating conditions

| | | S | SN54F352 | | | SN74F352 | | | |
|-----------------|--------------------------------|-----|----------|------|-----|----------|------|------|--|
| | | MIN | NOM | MAX | MiN | NOM | MAX | UNIT | |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V | |
| V _{iH} | High-level input voltage | 2 | | | 2 | | , | V | |
| VIL | Low-level input voltage | | | 8.0 | | | 0.8 | V | |
| ЧK | Input clamp current | | | - 18 | | | - 18 | mΑ | |
| Іон | High-level output current | | | - 1 | | | - 1 | mA | |
| loL | Low-level autput current | | | 20 | | - | 20 | mΑ | |
| TΑ | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C | |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | TEST CONDITIONS | | | SN54F352 | | | SN74F352 | | |
|------------------|----------------------------|-------------------------|------|----------|-------|------------------|----------|-------|----|
| PARAMETER | TEST CON | MIN | TYP | MAX | MIN | TYP [†] | MAX | UNIT | |
| Vik | V _{CC} = 4.5 V. | I _I = -18 mA | | | -1.2 | | | -1.2 | ٧ |
| V | V _{CC} = 4.5 V, | I _{OH} = -1 mA | 2.5 | 3.4 | | 2.5 | 3.4 | | V |
| ∨он — | $V_{CC} = 4.75 \text{ V},$ | IOH = -1 mA | | | | 2.7 | | | ľ |
| VOL | VCC = 4.5 V. | IOL = 20 mA | | 0.3 | 0.5 | | 0.3 | 0.5 | V |
| lį | $V_{CC} = 5.5 V$, | V _I = 7 V | | _ | 0.1 | | | 0.1 | mA |
| Т ИН | V _{CC} = 5.5 V, | V _I = 2.7 V | | | 20 | | | 20 | μА |
| I ₁ L | $V_{CC} = 5.5 V$ | V _I = 0.5 V | | | ~0.6 | [| | -0.6 | mΑ |
| los [‡] | $V_{CC} = 5.5 V,$ | V ₀ = 0 | - 60 | | - 150 | -60 | | - 150 | mΑ |
| 1ссн | V _{CC} = 5.5 V, | | | 9.3 | 14 | | 9.3 | 14 | mA |
| CCL | $V_{CC} = 5.5 V$, | | | 13.3 | 20 | | 13.3 | 20 | mA |

switching characteristics (see Note 1)

| PARAMETER | FROM (INPUT) | то (оитрит) | C _L | = 50 = 50 = 500 | oF, Ω, | | VCC = 4.5 CL = 50 pl RL = 500 t TA = MIN | F, Ω, to MAX [§] | | UNIT | |
|------------------|-----------------|----------------|----------------|---------------------------|-----------|-----|---|---------------------------------|------|------|----|
| [| | | ′F352 | | | SN5 | 4F352 | SN74F352 | | | |
| | | 1 | MIN | TYP | MAX | MIN | MAX | MIN | MAX | | |
| t _{PLH} | | | 2.7 | 7.6 | 11 | 2.2 | 14 | 2.2 | 12.5 | | |
| tPHL | A or B | Y | , r | 2.2 | 6.1 | B.5 | 1.7 | 11 | 1.7 | 9.5 | ns |
| tPLH | | | 1.7 | 4.1 | 6 | 1.2 | 8 | 1.2 | 7 | | |
| tPHL | G | Y | 2.2 | 4.6 | 7 | 1.7 | 9 | 1.7 | 8 | ns | |
| tPLH | Data | Y | 1.7 | 4.8 | 7 | 1.2 | 9 | 1.2 | 8 | | |
| tPHL | (Any C) | | 1 | 2.1 | 3.5 | 1 | 5 | 1 | 4 | ns | |

 $^{^{\}dagger}$ All typical values are at V_{CC} = 5 V, T_{A} = 25 °C.

NOTE 1: Load circuits and waveforms are shown in Section 1.

^{*}Not more than one output should be shorted at a time and the duration of the short circuit should not exceed one second.

For conditions shown as MIN or MAX, use the appropriate value specified under Recommended Operating Conditions.

IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.

Copyright © 1996, Texas Instruments Incorporated

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.

Copyright © 1998, Texas Instruments Incorporated